



BU160Z-178-HT Information

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For Reference Only

Part Number BU160Z-178-HT

Manufacturer On Shore Technology Inc.

Category Connectors, Interconnects
Sockets for ICs, Transistors

Description CONN IC DIP SOCKET 16POS GOLD

Package -

For the pricing/inventory/lead time, please contact

us

Website: https://www.heisener.com E-mail: salesdept@heisener.com



Request a Quote

Certified Quality

Heisener's commitment to quality has shaped our processes for sourcing, testing, shipping, and every step in between. This foundation underlies each component we sell.









BU160Z-178-HT Specifications

Manufacturer Part Number	BU160Z-178-HT	
Manufacturer	On Shore Technology Inc.	
Category	Connectors, Interconnects	
	Sockets for ICs, Transistors	
Package	-	
Series	BU-178HT	
Туре	DIP, 0.3" (7.62mm) Row Spacing	
Number of Positions or Pins (Grid)	16 (2 x 8)	
Pitch - Mating	0.100" (2.54mm)	
Contact Finish - Mating	Gold	
Contact Finish Thickness - Mating	78.7µin (2.00µm)	
Contact Material - Mating	Beryllium Copper	
Mounting Type	Surface Mount	
Features	Open Frame	
Termination	Solder	
Pitch - Post	0.100" (2.54mm)	
Contact Finish - Post	Copper	
Contact Finish Thickness - Post	Flash	
Contact Material - Post	Brass	
Housing Material	Polybutylene Terephthalate (PBT), Glass Filled	
Operating Temperature	-55°C ~ 125°C	
		Report errors?

BU160Z-178-HT Guarantees



Quality Guarantees

We provide 90 days warranty. *

If the items you received were not in perfect quality, we would be responsible for your refund or replacement, but the items must be returned in their original condition.



Service Guarantees

We guarantee 100% customer satisfaction.

Our experienced sales team and tech support team back our services to satisfy all our customers.

BU160Z-178-HT Payment Methods



















BU160Z-178-HT Shipping Methods













If you have any question about BU160Z-178-HT, please do not hesitate to contact us!

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